

Spin-on-Glass Ga-100

Elements of Interest Si, O, Ga	Key Element atoms/cm³ Ga, 4E+21	Key Element % in Film Gallium
Viscosity, η (635nm) 0.9 cps, 1.5	Thickness Coats 190 nm at 3000 rpm	Shelf Life 20°C 3 months 4°C 9 months

Benefits

- Heavy Gallium doping level
- Uniform Coatings
- High purity materials
- Lower melting point than silica alone
- Stable processing independent of flow rates
- Available with impurity specification of less than 1 ppm or less than 50 ppb

Typical Application

This is a standard silicate gallium doped glass very typical for semiconductor applications. It begins curing at about 200°C to give a less dense but solid film. It continues to become increasingly stronger as bakes continue to 650°C or higher. We recommend baking at the highest temperature the material will see in any post processing. For doping applications the glass is often removed after drive in.

Packaging

- 240ml
- 500ml
- 1 l
- 2.5 l
- 4 l

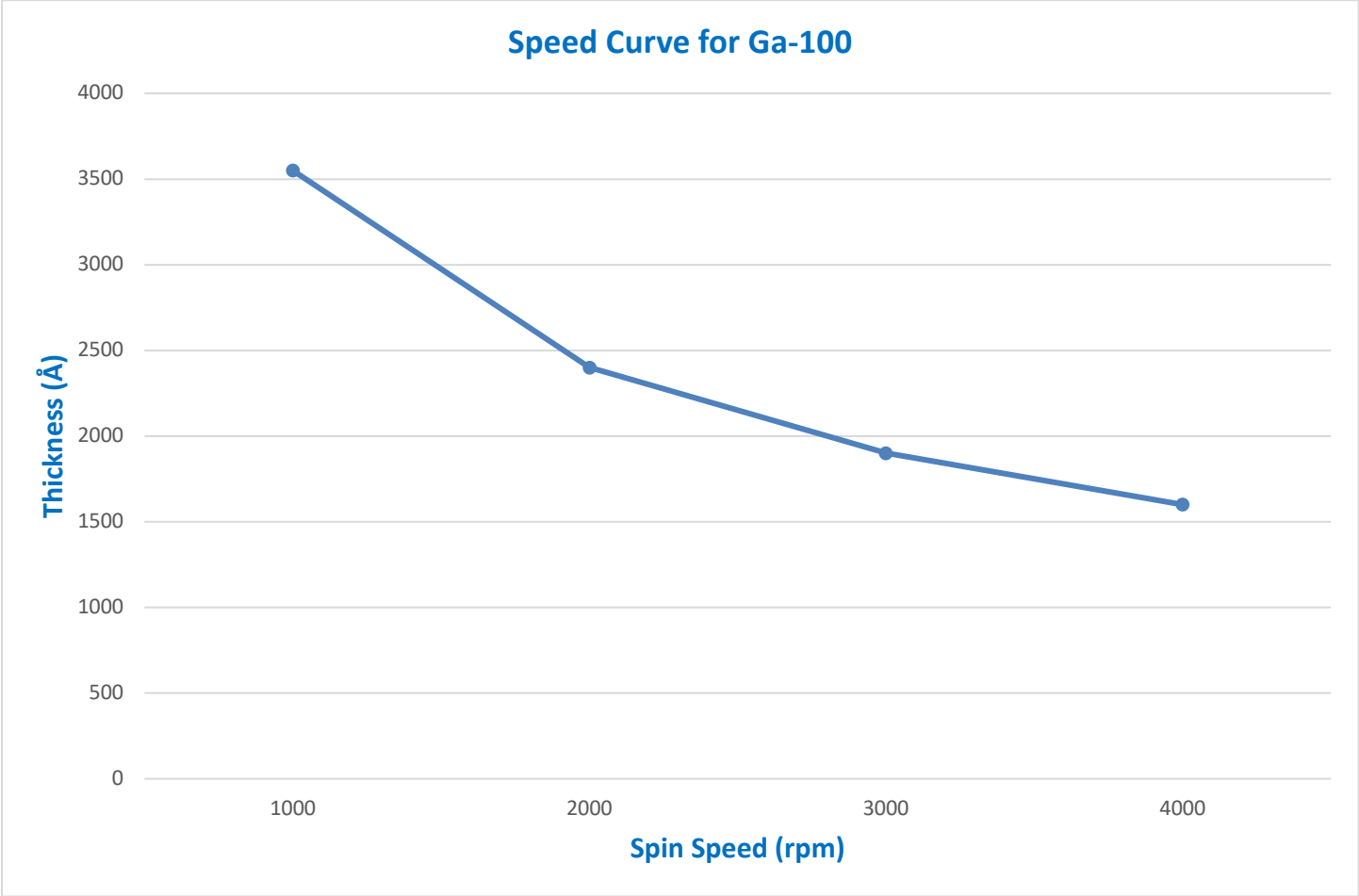
Alternative Products

- GaB-220

Alternate Elements to Add

- Blends of two or more elements
- Other elements available for compound semiconductor use

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